

Anomalous Output Characteristics

- Anomalous output characteristics are observed in hydrodynamic simulations of partially depleted SOI MOSFETs (Fig. 1).
- The current drop is not observed in drift-diffusion simulations and its occurrence in measurements is questionable.
- The drop in the drain current has been reproduced using the two different device simulators namely MINIMOS-NT and DESSIS.
- The applicability of the hydrodynamic model to the ever down-scaled devices is nevertheless desirable, because in contrast to the drift-diffusion model it takes non-local effects into account.
- Empirical measures provided by DESSIS, such as weighting heat flow and thermal diffusion, have only little influence on the current drop.
- The drop can be explained by an enhanced diffusion of channel hot carriers into the floating body.

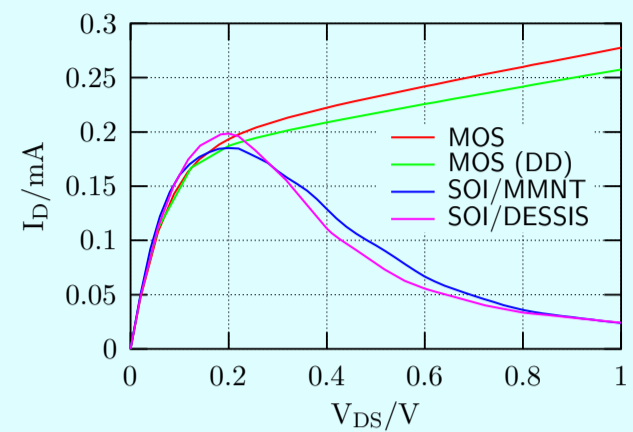


Fig. 1: Output characteristics obtained by standard DD and HD simulations.

Cause of the Effect

- The electron diffusion is significantly higher with the HD transport model due to the increased carrier temperature (Fig. 2 and Fig. 3).
- This increased diffusion has a strong impact on the body potential, because the hot electrons of the pinch-off region enter the floating body where they recombine.
- The holes removed by recombination cause the body potential to drop.
- The decrease in the output characteristics is directly connected to the drop of the body potential via the body-effect.

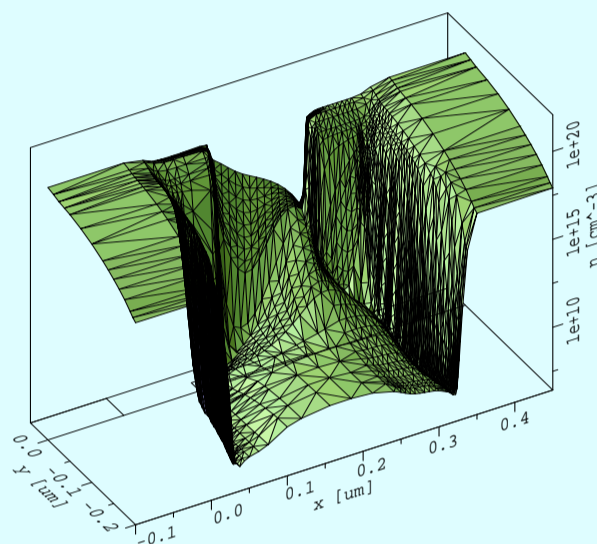


Fig. 2: Electron concentration in a MOSFET obtained by a hydrodynamic simulation.

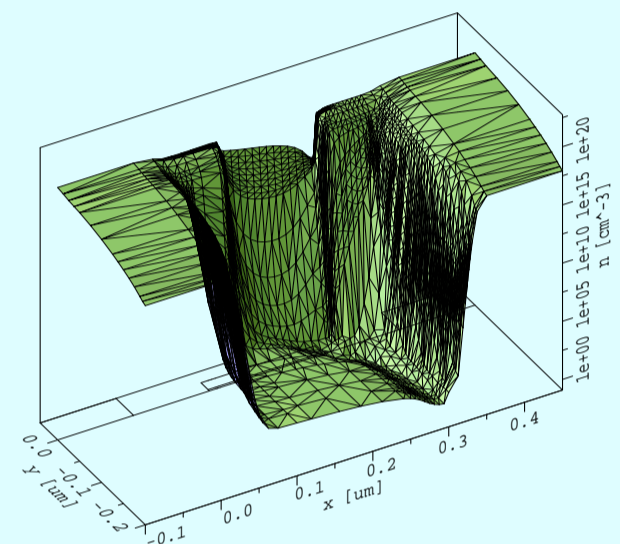


Fig. 3: Electron concentration in a MOSFET obtained by a drift-diffusion simulation.

Monte Carlo Investigations

- Monte Carlo simulations of a 90 nm and a 180 nm MOSFET have been performed.
- The simulations showed that the spreading of hot carriers away from the interface is much less pronounced than in hydrodynamic simulations which indicates an anisotropic carrier temperature (Fig. 4).
- In most parts of the channel the high energy tail is less populated than that of a MAXWELLIAN distribution, which gives a kurtosis $\beta_n < 1$ (Fig. 5).

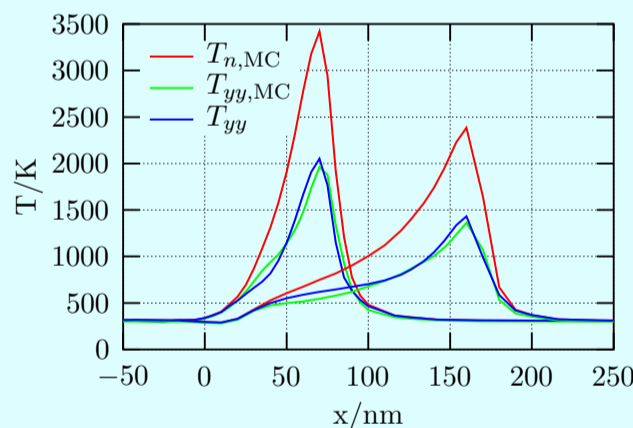


Fig. 4: MC simulation of two MOSFETs showing the y-component of the temperature and the temperature $T_{n,MC}$ from the mean energy.

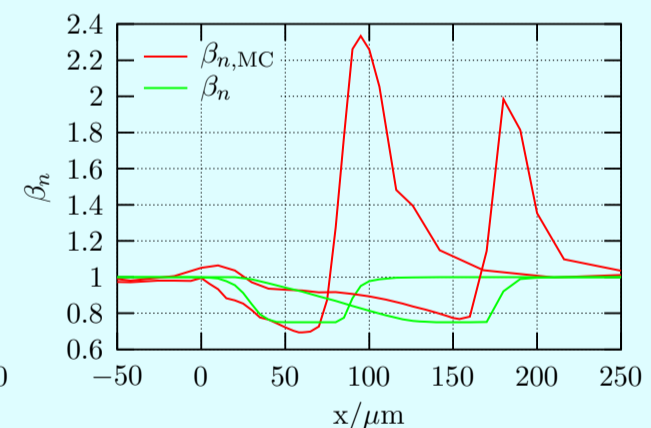


Fig. 5: MC simulation of two MOSFET showing the normalized moment of fourth order $\beta_{n,MC}$ compared to the analytical β_n .

Modified Transport Model

- By combining the modifications for an anisotropic temperature and a non-MAXWELLIAN closure relation the artificial current decrease gets eliminated (Fig. 6).
- Parameter values estimated from MC simulations can be used, e.g. $\gamma_{0y} = 0.75$ and $\beta_0 = 0.75$.
- In the parameter range where the current drop is eliminated the output characteristics are found to be rather insensitive to the exact parameter values.

$$J_{n,\xi} = \mu_n \left(k_B \frac{\partial}{\partial \xi} (n T_{\xi\xi}) + q E_{\xi} n \right),$$

$$S_{n,\xi} = -\frac{5}{2} \frac{k_B}{q} \mu_S \left(k_B \frac{\partial}{\partial \xi} (n \beta_n T_{\xi\xi} \Theta) + q E_{\xi} n \Theta \right), \quad \Theta = \frac{3T_n + 2T_{\xi\xi}}{5},$$

$$T_{\xi\xi} = T_{xx} \cos^2 \varphi + T_{yy} \sin^2 \varphi, \quad T_{\nu\nu} = \gamma_{\nu} T_n,$$

$$\gamma_{\nu}(T_n) = \gamma_{0\nu} + (1 - \gamma_{0\nu}) \exp \left(-\left(\frac{T_n - T_L}{T_{ref,\gamma}} \right)^2 \right),$$

$$\nu = x, y,$$

$$\beta_n(T_n) = \beta_0 + (1 - \beta_0) \exp \left(-\left(\frac{T_n - T_L}{T_{ref,\beta}} \right)^2 \right)$$

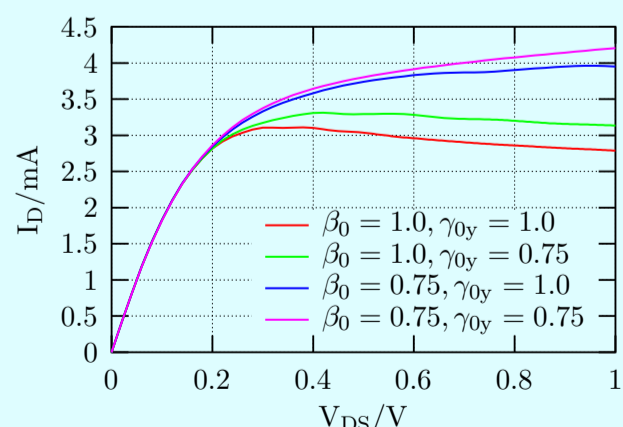


Fig. 6: Output characteristics of the "Well-Tempered" SOI at $V_{GS} = 1V$. The spurious decrease got eliminated.